

# Distance linear image sensor



S11961-01CR

# Measures the distance to an object by TOF (Time-Of-Flight) method

The distance image sensors are designed to measure the distance to an object by TOF method. When used in combination with a pulse modulated light source, this sensor outputs phase difference information on the timing that the light is emitted and received. The sensor output signals are arithmetically processed by an external signal processing circuit or a PC to obtain distance data. We provide an evaluation kit for this product. Contact us for detailed information.

### Features

- High-speed charge transfer structure
- Wide dynamic range, low noise by non-destructive readout
- Operates with minimal detection errors even under fluctuating (charge drain function)
- **Real-time distance measurement**

### Applications

- Obstacle detection (self-driving, robots, etc.)
- Security (intrusion detection, etc.)
- Shape recognition (logistics, robots, etc.)
- Motion capture

### **Structure**

Parameter	Specification	Unit
Image size	5.12 × 0.05	mm
Pixel pitch	20	μm
Pixel height	50	μm
Number of pixels	272	pixels
Number of effective pixels	256	pixels
Package	22-pin PWB	-
Window material	AR-coated glass	-

Note: This product is not hermetically sealed.

### **→** Absolute maximum ratings

	Parameter	Symbol	Condition	Value	Unit
Analog supply voltage		Vdd(A)	Ta=25 °C	-0.3 to +6	V
Digital supply voltage		Vdd(D)	Ta=25 °C	-0.3 to +6	V
Pixel amplifier		Vsf			
Analog input terminal voltage	Pixel reset	Vr	Ta=25 °C	-0.3 to Vdd(A) + 0.3	V
voitage	Photosensitive area	Vpg			
	Pixel reset pulse	p_res			
Digital input torminal	Signal sampling pulse	phis			
Digital input terminal voltage	Master clock pulse	mclk Ta=25 °		-0.3 to Vdd(D) + 0.3	V
voitage	Signal readout trigger pulse	trig			
	Output signal synchronous pulse	dclk			
Charge transfer clock pulse voltage		VTX1, VTX2, VTX3	Ta=25 °C	-0.3 to Vdd(A) + 0.3	V
Operating temperature		Topr	No dew condensation*1	-25 to +85	°C
Storage temperature		Tstg	No dew condensation*1	-40 to +100	°C
Reflow soldering conditions*2		Tsol		260 °C max. 2 times (see P.8)	-

<sup>\*1:</sup> When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

### **➡** Recommended terminal voltage (Ta=25 °C)

Parameter		Symbol	Min.	Тур.	Max.	Unit
Analog supply voltage		Vdd(A)	4.75	5	5.25	V
Digital supply voltage	Digital supply voltage		4.75	5	5.25	V
	Pixel amplifier	Vsf	4.5	5	Vdd(A)	V
Bias voltage	Pixel reset	Vr	4	4.25	4.5	V
	Photosensitive area	Vpg	0.8	1.0	1.2	V
Divol recet pulse voltage	High level	n roc	$Vdd(D) \times 0.8$	-	-	V
Pixel reset pulse voltage	Low level	p_res	-	-	$Vdd(D) \times 0.2$	V
Signal sampling pulse voltage	High level	phic	$Vdd(D) \times 0.8$	-	-	V
	Low level	phis	-	-	$Vdd(D) \times 0.2$	<b>'</b>
Master clock pulse voltage	High level	mclk	$Vdd(D) \times 0.8$	-	-	V
Master clock pulse voltage	Low level	HICK	-	-	$Vdd(D) \times 0.2$	V
Signal readout trigger pulse	High level	tuia	$Vdd(D) \times 0.8$	-	-	V
voltage	Low level	trig	-	-	$Vdd(D) \times 0.2$	V
Output signal synchronous pulse	High level	dclk	$Vdd(D) \times 0.8$	-	-	V
voltage Low level		ucik	-	-	$Vdd(D) \times 0.2$	V

### **■** Electrical characteristics [Ta=25 °C, Vdd(A)=Vdd(D)=5 V]

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Clock pulse frequency	f(mclk)		1 M	-	5 M	Hz
Video data rate	VR		-	f(mclk)	-	Hz
Current consumption	Ic	Dark state	-	15	30	mA

## **■** Electrical and optical characteristics [Ta=25 °C, Vdd(A)=Vdd(D)=5 V, Vsf=5 V, Vr=4.25 V, MCLK=5 MHz]

Parameter	Symbol	Min.	Тур.	Max.	Unit	
Spectral response range	λ		400 to 1100			
Peak sensitivity wavelength	λр	-	800	-	nm	
Photosensitivity*3	S	$1.05 \times 10^{12}$	$2.1 \times 10^{12}$	$4.2 \times 10^{12}$	V/W·s	
Dark output	Vd	-	0.5	10	V/s	
Random noise	RN	-	0.4	0.8	mV rms	
Dark output voltage*4	Vor	2.95	3.3	4.35	V	
Saturation output voltage	Vsat	-	-	2	V	
Sensitivity ratio*5	SR	0.7	-	1.43	-	
Photoresponse nonuniformity*6	PRNU	-	-	±10	%	

<sup>\*3:</sup> Monochromatic wavelength source (λ=805 nm)

 $PRNU = \Delta X/X \times 100 [\%]$ 

X: average output of all pixels, ΔX: difference between X and maximum or minimum output

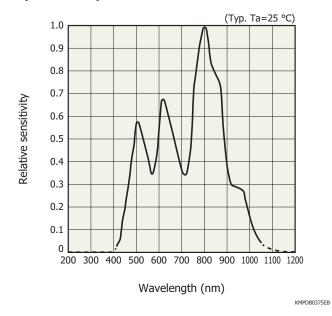


<sup>\*4:</sup> Output voltage right after reset in dark state

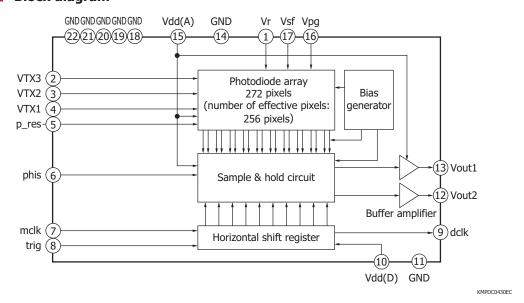
<sup>\*5:</sup> Sensitivity ratio of Vout1 (VTX1=3 V, VTX2=VTX3=0 V) to Vout2 (VTX2=3 V, VTX1=VTX3=0 V)

<sup>\*6:</sup> Photoresponse nonuniformity (PRNU) is the output nonuniformity that occurs when the entire photosensitive area is uniformly illuminated by light which is 50% of the saturation exposure level. PRNU is measured using 256 pixels excluding 8 pixels each at both ends, and is defined as follow:

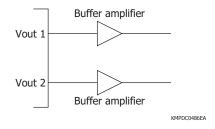
### Spectral response



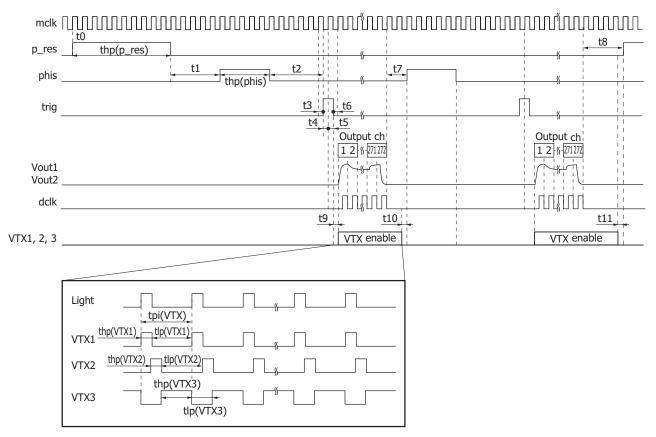
### **Block diagram**



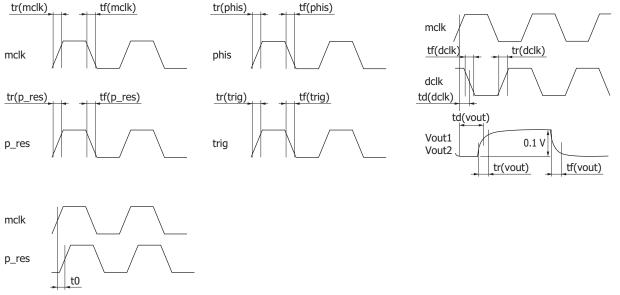
### **Basic connection example**



### - Timing chart



KMPDC0431EB



KMPDC0432EA

### - Calculation method of frame rate

Frame rate=1/(Time per frame) =1/(Integration time + Readout time)

Integration time:

It is necessary to be changed by the required distance accuracy and usage environment factors such as fluctuating background light.

$$\mbox{Readout time} = \frac{1}{\mbox{Clock pulse frequency}} \times \mbox{Number of horizontal pixels}$$

=Time per clock (Readout time per pixel) × Number of horizontal pixels

Calculation example of readout time (clock pulse frequency: 5 MHz, number of horizontal pixels: 272)

Readout time= 
$$\frac{1}{5 \times 10^6 \, [\text{Hz}]} \times 272$$
  
=200 [ns] × 272  
=0.0544 [ms]

When operating in non-destructive readout mode:

Time per frame=Integration time + (Readout time × Non-destructive readout count)



Symbol - tr(mclk), tf(mclk) thp(p_res) tr(p_res), tf(p_res)	Min. 45 0	Typ. 50 -	Max. 55	Unit %
thp(p_res)	0			70
thp(p_res)	-		20	ns
	10	_	-	μs
	0	_	20	ns
	-	_	-	μs
		-	20	ns
	-	_		ns
	0	-	-	ns
t1	1	-	-	μs
ιz	1.2	-	-	μs
13	1/4 × 1/f(mclk)	-	1/2 × 1/f(mclk)	S
14	1/4 × 1/f(mclk)	-	1/2 × 1/f(mclk)	S
15	1/4 × 1/f(mclk)	-	1/2 × 1/f(mclk)	S
to	1/4 × 1/f(mclk)	-	1/2 × 1/f(mclk)	S
f t7	1/f(mclk)	-	-	S
l t8	1/f(mclk)	-	-	S
tu(ucik)	0	25	50	ns
tr(dcik)	-	20	40	ns
tr(acik)	-	20	40	ns
tr(Vout), tf(Vout)	-	35	70	ns
td(Vout)	-	40	80	ns
tpi(VTX)	60	-	-	ns
thp(VTX1)	30	-	-	ns
tlp(VTX1)	-	tpi(VTX) - thp(VTX2) - thp(VTX3)	-	ns
thp(VTX2)	30	-	-	ns
tlp(VTX2)	-	tpi(VTX) - thp(VTX1) - thp(VTX3)	-	ns
thp(VTX3)	0	-	-	ns
tlp(VTX3)	-	tpi(VTX) - thp(VTX1) - thp(VTX2)	-	ns
tr(VTX)	-	3	-	ns
tf(VTX)	-	3	-	ns
VTX1, VTX2, VTX3	-	3		V
t9	1/f(mclk)	-	-	S
f t10	1/f(mclk)	-	-	S
t11	1/f(mclk)	-	-	S
	thp(phic) tr(phic), tf(phic) tr(phic), tf(phic) tr(trig), tf(trig)  t0  t1  t2  t3  t4  t5  t6  t7  t8  td(dclk) tr(dclk) tr(dclk) tr(Vout), tf(Vout) td(Vout) tpi(VTX1) thp(VTX1) thp(VTX1) thp(VTX2) thp(VTX3) tr(VTX) tf(VTX)	thp(phic) 1 tr(phic), tf(phic) 0 tr(trig), tf(trig) 0 tr(trig), tf(trig) 0 tr(trig), tf(trig) 0 tr(trig), tf(trig) 0 tt 1 1 to 0 0 tt 1 1 tt 1 tt 2 1.2 tt 3 1/4 × 1/f(mclk) tt 4 1/4 × 1/f(mclk) tt 5 1/4 × 1/f(mclk) tt 6 1/4 × 1/f(mclk) tt 7 1/f(mclk) tt 8 1/f(mclk) tt td(dclk) 0 tt tr(dclk) - tr(dclk) - tr(vout), tf(vout) - tt td(Vout) - tt td(Vout) - tt td(Vout) - tt thp(VTX1) 30 tlp(VTX1) 30 tlp(VTX2) - thp(VTX3) 0 tlp(VTX3) 0 tlp(VTX3) - tr(VTX) - tf(VTX) - tf(mclk)	thp(phic) 1	thp(phic) tr(phic) tr(phic) tr(phic) tr(phic) tr(phic) tr(phic) tr(phic) tr(trig) tr



<sup>\*7:</sup> CL=3 pF \*8: Output voltage=0.1 V

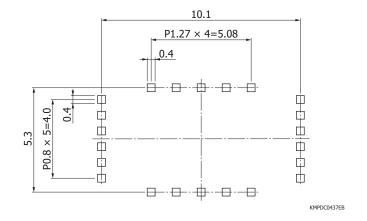
### **Input terminal capacitance (Ta=25 °C, Vdd=5 V)**

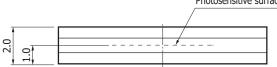
Parameter	Symbol	Min.	Тур.	Max.	Unit
Charge transfer clock pulse internal load capacitance	CLTX	-	25	-	pF

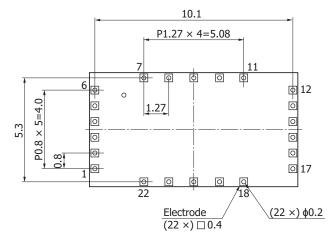
### Dimensional outline (unit: mm)

# Photosensitive area S.12 × 0.05 Hole \$\frac{\text{Hole}}{\pho.2}\$ Photosensitive surface

## - Recommended land pattern (unit: mm)







Tolerance unless otherwise noted: ±0.2, ±2°

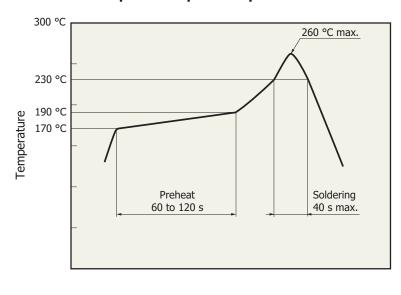
KMPDA0298EC

### - Pin connections

Pin no.	Symbol	I/O	Description
1	Vr	I	Bias voltage (pixel reset)
2	VTX3	I	Charge transfer clock pulse 3
3	VTX2	I	Charge transfer clock pulse 2
4	VTX1	I	Charge transfer clock pulse 1
5	p_res	I	Pixel reset pulse
6	phis	I	Signal sampling pulse
7	mclk	I	Master clock pulse
8	trig	I	Signal readout trigger pulse
9	dclk	0	Output signal synchronous pulse
10	Vdd(D)	I	Digital supply voltage
11	GND	I	Ground
12	Vout2	0	Output signal 1
13	Vout1	0	Output signal 2
14	GND	I	Ground
15	Vdd(A)	I	Analog supply voltage
16	Vpg	I	Bias voltage (photosensitive area)
17	Vsf	I	Bias voltage (pixel amplifier)
18	GND	I	Ground
19	GND	I	Ground
20	GND	I	Ground
21	GND	I	Ground
22	GND	I	Ground

Note: Connect an impedance converting buffer amplifier to Vout1/Vout2 so as to minimize the current flow.

### **▶** Measured example of temperature profile with our hot-air reflow oven for product testing



Time

KMPDB0381EA

- This product supports lead-free soldering. After unpacking, store it in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform soldering within 168 hours.
- The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. Before actual reflow soldering, check for any problems by testing out the reflow soldering methods in advance.



### Distance linear image sensor

S11961-01CR

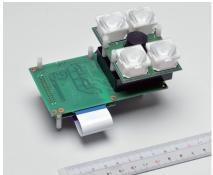
### Related information

www.hamamatsu.com/sp/ssd/doc\_en.html

- Precautions
- · Disclaimer
- · Surface mount type products
- · Image sensors

### Evaluation kit for distance linear image sensor (S11961-01CR)

An evaluation kit [110 mm (H) × 70 mm (V)] for understanding the operating principle of Hamamatsu's S11961-01CR distance linear image sensor is available. Contact us for detailed information.



Information described in this material is current as of February, 2018.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

The product warranty is valid for one year after delivery and is limited to product repair or replacement for defects discovered and reported to us within that one year period. However, even if within the warranty period we accept absolutely no liability for any loss caused by natural disasters or improper product use. Copying or reprinting the contents described in this material in whole or in part is prohibited without our prior permission.

# MAMATSU

www.hamamatsu.com

HAMAMATSU PHOTONICS K.K., Solid State Division

1126-1 Ichino-cho, Higashi-ku, Hamamatsu City, 435-8558 Japan, Telephone: (81) 53-434-3311, Fax: (81) 53-434-5184

1126-1 ICTIIIIO-CTIO, HIgdsTil-RU, Halmamatsu City, 435-6558 Japan, Telephone: (81) 53-434-5111, FaX: (61) 53-434-51184
U.S.A.: Hamamatsu Corporation: 360 Foothill Road, Bridgewater, N.J. 08807, U.S.A., Telephone: (1) 908-231-0960, Fax: (1) 908-231-1218, E-mail: usa@hamamatsu.com
Germany: Hamamatsu Photonics Deutschland GmbH: Arzbergerstr. 10, D-82211 Herrsching am Ammersee, Germany, Telephone: (49) 8152-375-0, Fax: (49) 8152-265-8, E-mail: info@hamamatsu.de
France: Hamamatsu Photonics France S.A.R.L.: 19, Rue du Saule Trapu, Parc du Moulin de Massy, 91882 Massy Cedex, France, Telephone: 33-(1) 69 53 71 00, Fax: 33-(1) 69 53 71 10, E-mail: info@hamamatsu.fr
United Kingdom: Hamamatsu Photonics Itali Limited: 2 Howard Court, 10 Tewin Road, Welvyn Garden Gity, Hertfordshire ALT 18W, United Kingdom, Telephone: (41) 707-294888, Fax: (44) 1707-2925777, E-mail: info@hamamatsu.com.cn
North Europe: Hamamatsu Photonics Norden AB: Torshamnsgatan 35 16440 kista, Sweden, Telephone: (46)8-509 031 00, Fax: (46)8-509 031 01, E-mail: info@hamamatsu.se
Italy: Hamamatsu Photonics (China) Co., Ltd.: 81201, Jiaming Center, No.27 Dongsanhuan Bellu, Chaoyang District, Beijing 100020, China, Telephone: (86) 10-6586-6006, Fax: (86) 10-6586-2866, E-mail: info@hamamatsu.com.cn
Taiwan: Hamamatsu Photonics Taiwan Co., Ltd.: 8F-3, No. 158, Section2, Gongdao 5th Road, East District, Hsinchu, 300, Taiwan R.O.C. Telephone: (886)03-659-0081, E-mail: info@hamamatsu.com.tw